



Final Product Change Notification

201502004F01

Issue Date: 13-Feb-2015

Effective Date: 28-May-2015

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QUALITY

Management Summary

Change of wafer diameter from 6 to 8 inch.

Reduction of max. specified leakage current.

Change Category

<input checked="" type="checkbox"/> Wafer Fab process	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Product Marking	<input type="checkbox"/> Design
<input checked="" type="checkbox"/> Wafer Fab materials	<input type="checkbox"/> Assembly Materials	<input checked="" type="checkbox"/> Electrical spec./Test coverage	<input type="checkbox"/> Mechanical Specification
<input checked="" type="checkbox"/> Wafer Fab location	<input type="checkbox"/> Assembly Location	<input type="checkbox"/> Test Location	<input type="checkbox"/> Packing/Shipping/Labeling

IP3319CX6: Change of wafer diameter from 6 to 8 inch

Details of this Change

Change of wafer diameter from 6 to 8 inch and transfer from DHAM Fab (Hamburg, Germany) to ICN8 Fab(Nijmegen, The Netherlands).

According to this the max. specified leakage current will also be reduced from 1 μ A to 100nA.

Why do we Implement this Change

- Wafer fab process standardization.
- Increase of production capacity.

Identification of Affected Products

Packing labels

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment 28-May-2015

Impact

no impact to the product's functionality anticipated.

Data Sheet Revision

A new datasheet will be issued

Disposition of Old Products

Existing inventory will be shipped until depleted

Timing and Logistics

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 15-Mar-2015.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Carsten Lutterloh
Position Quality Manager
e-mail address carsten.lutterloh@nxp.com

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Customer Focus, Passion to Win.

NXP Quality Management Team.

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High Tech Campus, 5656 AG Eindhoven, The Netherlands

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